

Triac Medium Power Use

> REJ03G0329-0200 Rev.2.00 Nov.09.2004

Features

- I_{T (RMS)} : 20 A
- V_{DRM} : 600 V
- I_{FGTI} , I_{RGTI} , I_{RGT} : 30 mA (20 mA)^{Note5}
- Viso : 2000 V

• Planar Passivation Type

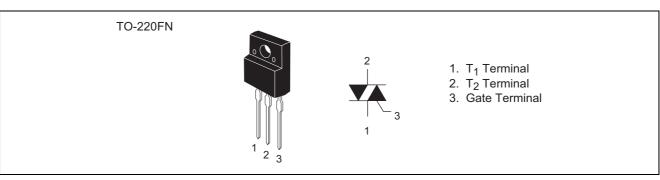
•

Insulated Type

• UL Recognized : Yellow Card No. E223904 File No. E80271

• VISO . 20

Outline



Applications

Vacuum cleaner, electric heater, light dimmer, copying machine, and other general controlling devices

Maximum Ratings

Parameter	Symbol	Voltage class	Unit	
Falameter	Symbol	12		
Repetitive peak off-state voltage ^{Note1}	V _{DRM}	600	V	
Non-repetitive peak off-state voltage ^{Note1}	V _{DSM}	720	V	

BCR20KM-12L

Parameter	Symbol	Ratings	Unit	Conditions	
RMS on-state current	I _{T (RMS)}	20	A	Commercial frequency, sine full wave 360° conduction, Tc = 85°C	
Surge on-state current	I _{TSM}	200	A	60Hz sinewave 1 full cycle, peak value, non-repetitive	
I ² t for fusing	l ² t	167	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current	
Peak gate power dissipation	P _{GM}	5	W		
Average gate power dissipation	P _{G (AV)}	0.5	W		
Peak gate voltage	V _{GM}	10	V		
Peak gate current	I _{GM}	2	А		
Junction temperature	Tj	- 40 to +125	°C		
Storage temperature	Tstg	- 40 to +125	°C		
Mass	_	2.0	g	Typical value	
Isolation voltage	Viso	2000	V	Ta = 25°C, AC 1 minute, T ₁ ·T ₂ ·G terminal to case	

Notes: 1. Gate open.

Electrical Characteristics

Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak off-state cur	rent	I _{DRM}		—	2.0	mA	Tj = 125°C, V _{DRM} applied
On-state voltage		V _{TM}	_	—	1.5	V	$Tc = 25^{\circ}C$, $I_{TM} = 30$ A, Instantaneous measurement
Gate trigger voltage ^{Note2}	Ι	V _{FGTI}	_	—	1.5	V	$Tj = 25^{\circ}C, V_D = 6 V, R_L = 6 \Omega,$
	II	V _{RGTI}		—	1.5	V	$R_G = 330 \Omega$
	III	V _{RGTIII}		—	1.5	V	
Gate trigger current ^{Note2}	Ι	I _{FGTI}	_	—	30 ^{Note5}	mA	$Tj=25^{\circ}C,\ V_D=6\ V,\ R_L=6\ \Omega,$
	II	I _{RGTI}		—	30 ^{Note5}	mA	R _G = 330 Ω
	III	I _{RGTIII}		_	30 ^{Note5}	mA	
Gate non-trigger voltage		V _{GD}	0.2	—	—	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM}$
Thermal resistance		R _{th (j-c)}	_	—	2.0	°C/W	Junction to case ^{Note3}
Critical-rate of rise of off-sta commutating voltage ^{Note4}	te	(dv/dt)c	10	—	—	V/µs	Tj = 125°C

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

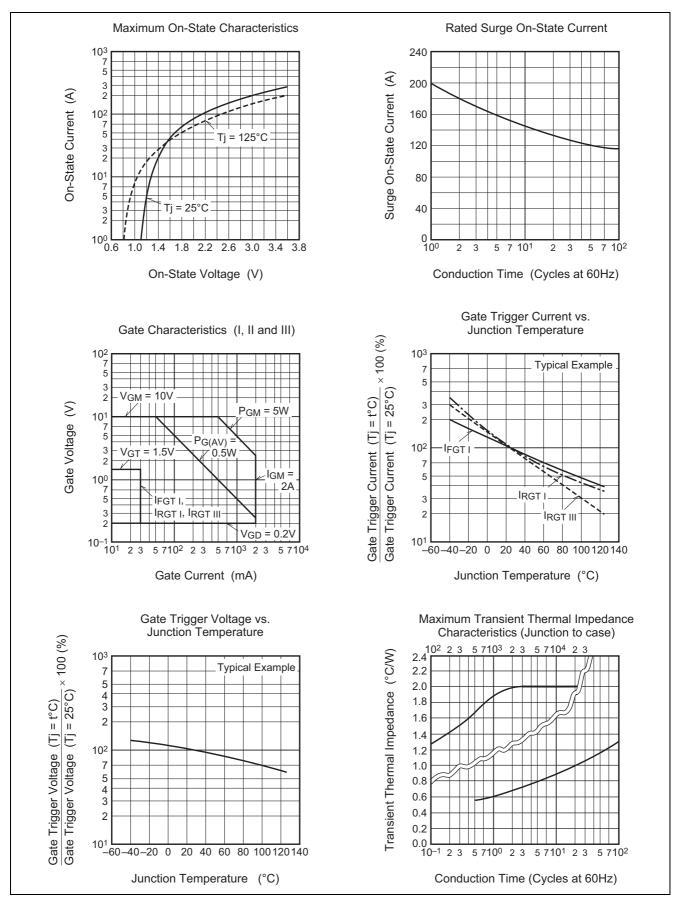
3. The contact thermal resistance $R_{th\,(c\text{-}f)}$ in case of greasing is 0.5°C/W.

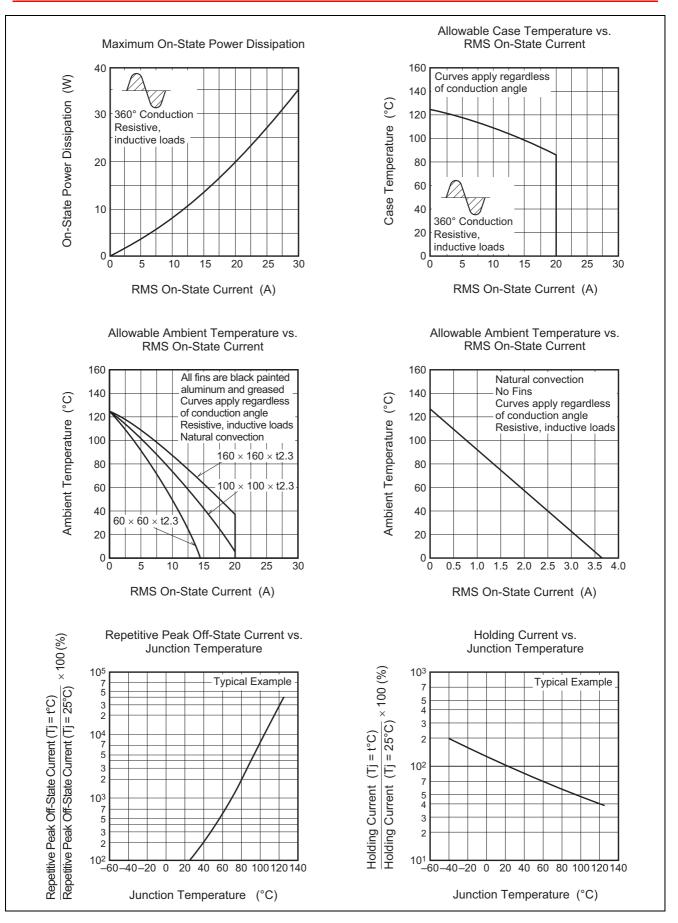
4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

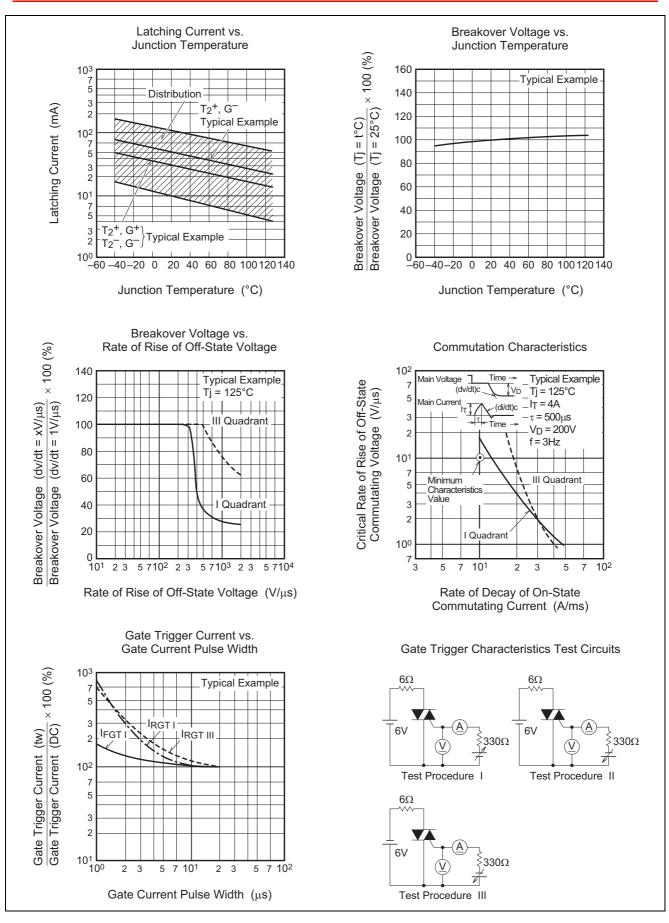
5. High sensitivity (I_{GT} \leq 20 mA) is also available. (I_{GT} item: 1)

Test conditions	Commutating voltage and current waveforms (inductive load)			
1. Junction temperature Tj = 125°C	Supply Voltage → Time			
 Rate of decay of on-state commutating current (di/dt)c = -10 A/ms 	Main Current → Time			
3. Peak off-state voltage $V_D = 400 \text{ V}$	Main VoltageTime (dv/dt)cV			

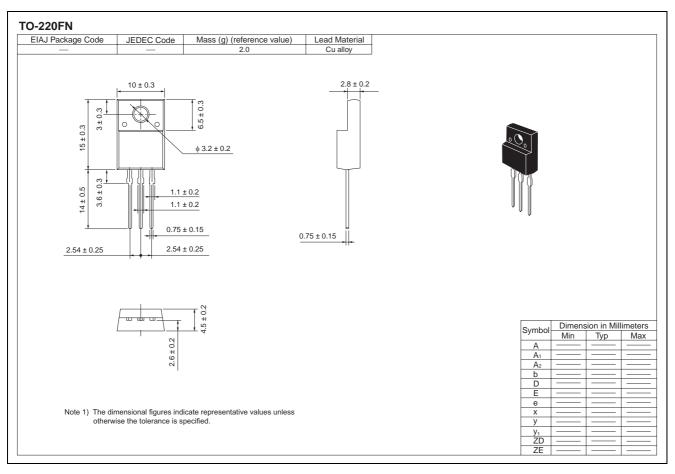
Performance Curves







Package Dimensions



Order Code

Standard packing	Quantity	Standard order code	Standard order code example
Plastic Magazine (Tube)	50	Type name +A	BCR20KM-12LA
Plastic Magazine (Tube)	50	Type name +A – Lead forming code	BCR20KM-12LA-A8
	Plastic Magazine (Tube)	Plastic Magazine (Tube)50	Plastic Magazine (Tube) 50 Type name +A

Note : Please confirm the specification about the shipping in detail.

Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs! 1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

- Notes regarding these materials
 These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
 Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
 All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. van a uthorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
 The information described here may contain technical inaccuracies or typographical errors. Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors. Please also pay attention to information before purchasion.
 When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information actual system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. an authorized Renesas Technology Corp. product distributor when co

- use. 6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials. 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination. Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited. 8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.



RENESAS SALES OFFICES

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

Renesas Technology America, Inc. 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K. Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology Hong Kong Ltd. 7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd. Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd. 1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

http://www.renesas.com